

Model Name: P215HAN01.2

Issue Date: 2022/05/27

()Preliminary Specifications

(*)Final Specifications

Customer Signature	Date	ADP	Date
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Record of Revision

Version	Date	Page	Description
0.0	2021/12/06	all	1st Preliminary spec release
0.1	2022/03/14	23	Update 2D drawing
1.0	2022/5/27	all	1st Final spec release
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1. General Description

This specification applies to the 21.5 inch Color TFT-LCD Module P215HAN01.2. This LCD module has a TFT active matrix type liquid crystal panel 1,920x1,080 pixels, and diagonal size of 21.5 inch. This module supports 1,920x1,080 resolution display. Each pixel is divided into Red, Green and Blue sub-pixels or dots which are arranged in vertical stripes. Gray scale or the brightness of the sub-pixel color is determined with a 8-bit gray scale signal for each dot.

The P215HAN01.2 has been designed to apply the 8-bit 2 channel LVDS interface method. It is intended to support displays where high brightness, wide viewing angle, high color saturation, and high color depth.

* General Information

Items	Specification	Unit	Note
Active Screen Size	21.5	Inch	
Display Area	476.064 (H) x 267.79 (V)	mm	
Outline Dimension	495.6 (H)× 292.2 (V)×10.7(D)	mm	
Driver Element	a-Si TFT active matrix		
Display Colors	16.7M colors (RGB 6-bits +Hi-FRC)	Colors	
Number of Pixels	1,920x1,080	Pixel	
Pixel Pitch	0.24795×0.24795	mm	
Pixel Arrangement	RGB vertical stripe		
Display Operation Mode	Normally Black		
Surface Treatment	AG, 3H	ntha	Haze 25%
Rotate Function	Unachievable		Note 1
Display Orientation	Landscape/Portrait Enable	150	Note 2
Operating Time	24/7		
Frame Rate	60	Hz	
LED MTTF	30K	hrs	

Note:

Note 1: Rotate Function refers to LCD display could be able to rotate. This function does not work in this model. Note 2:

1. Landscape Mode:

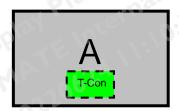
The default placement is T-Con Side on the lower side and the image is shown upright via viewing from the front.

2. Portrait Mode:

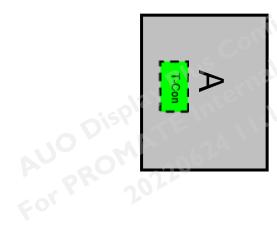
The default placement is that T-Con side has to be placed on the left side via viewing from the front.



Landscape (Front view)



Portrait (Front view)





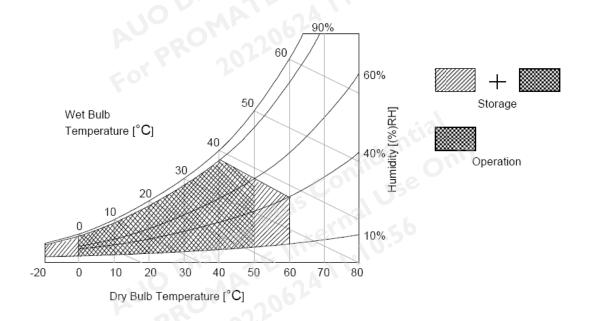
2. Absolute Maximum Ratings

AUO Display+			F213F	ANUI.Z FIC	Rev. 1.0
2. Absolute Maximu	ım Rating	sine Co	nfident.	only	
Item	Symbol	Min	Max	Unit	Conditions
Operating Temperature	TOP	0	+50	[°C]	Note 1
Operating Humidity	HOP	10	90	[%RH]	Note 1
Storage Temperature	TST	-20	+60	[°C]	Note 1
Storage Humidity	HST	10	90	[%RH]	Note 1
Panel Surface Temperature	PST		65	[°C]	Note 2

Note 1: Maximum Wet-Bulb should be 39°Cand No condensation.

The relative humidity must not exceed 90% non-condensing at temperatures of 40°C or less. At temperatures greater than 40°C, the wet bulb temperature must not exceed 39°C

Note 2: Surface temperature is measured at 50°C Dry condition

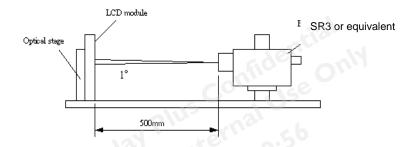




3. Optical Specification

Optical characteristics are determined after the unit has been 'ON' and stable for approximately 45 minutes in a dark environment at 25°C while panel is placed in the default position. The default position is T-con side as the top side of panel. The value specified is at an approximate distance 50cm from the LCD surface at a viewing angle of ϕ and θ equal to 0° .

Fig.1 presents additional information concerning the measurement equipment and method.



D	O mark al	10A	Values		l ladit	Notes	
Parameter	Symbol	Min.	Тур.	Max	Unit	Notes	
Contrast Ratio	CR		1000			1	
Surface Luminance (White)	L _{WH}	240	300		cd/m ²	2	
Luminance Variation	δwhite(9P)			1.33		3	
Response Time (G to G)	Тγ		14	131	ms	4	
Color Gamut	NTSC		72	$O_{U_{i,j}}$	%		
Color Coordinates		Co	1150				
Red	Rx	2/1/2	0.645				
	Ry	ter	0.335				
Green	Gx		0.312				
	G _Y	T = 0.00	0.621				
Blue	Bx	Typ0.03	0.153	Typ.+0.03			
201	Ву		0.053				
White	Wx		0.313				
	WY		0.329	al			
Viewing Angle			16UL	111		5	
x axis, right(φ=0°)	θ_{r}	85	89	O ''	degree		
x axis, left(φ=180°)	θι	85	89		degree		
y axis, up(φ=90°)	θυ	85	89		degree		
y axis, down (φ=270°)	θ_{d}	85	89		degree		



Note:

1. Contrast Ratio (CR) is defined mathematically as:

- 2. Surface luminance is luminance value at point 5 across the LCD surface 50cm from the surface with all pixels displaying white. From more information see FIG 2. When lamp current I_H = 11mA. LwH=Lon5 where Lon5 is the luminance with all pixels displaying white at center 5 location.
- 3. The variation in surface luminance, δ WHITE is defined (center of Screen) as:

 $\delta_{\text{WHITE(9P)}}$ = Maximum(L_{on1}, L_{on2},...,L_{on9})/ Minimum(L_{on1}, L_{on2},...L_{on9})

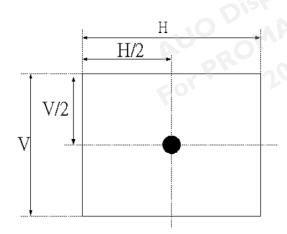
4. Response time T_{γ} is the average time required for display transition by switching the input signal for five luminance ratio (0%,25%,50%,75%,100% brightness matrix) and is based on F_{ν} =60Hz to optimize.

 T_{γ} is determined by 10% to 90% brightness difference of rising or falling period. (As illustrated)

Mea	asured		, C	Target		
Respo	nse Time	0%	25%	50%	75%	100%
	0%		0% to 25%	0% to 50%	0% to 75%	0% to 100%
	25%	25% to 0%		25% to 50%	25% to 75%	25% to 100%
Start	50%	50% to 0%	50% to 25%		50% to 75%	50% to 100%
	75%	75% to 0%	75% to 25%	75% to 50%		75% to 100%
	100%	100% to 0%	100% to 25%	100% to 50%	100% to 75%	

5. Viewing angle is the angle at which the contrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG4.

FIG.2 Luminance



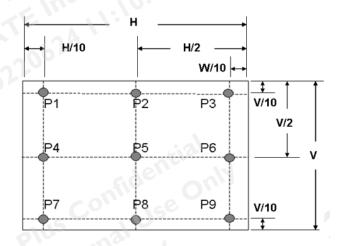
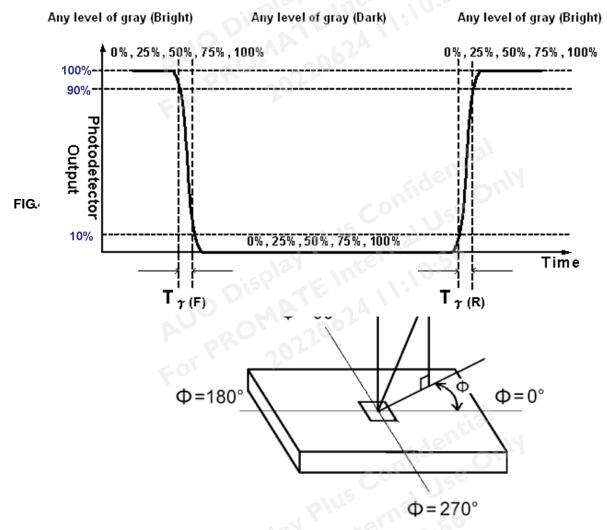




FIG.3 Response Time

The response time is defined as the following figure and shall be measured by switching the input signal for "any level of gray(bright) " and "any level of gray(dark)".





4. Interface Specification

4.1. Input power

The P215HAN01.2 module requires power inputs which are employed to power the LCD electronics and to drive the TFT array and liquid crystal.

4.1.1 Absolute Maximum Rating

Permanent damage may occur if exceeding the following maximum rating

Symbol	Description	Min	Max	Unit	Remark
VDD	Power Supply Input Voltage	GND-0.3	6.0	[Volt]	Ta=25°C

4.1.2 Recommended Operating Condition

Symbol	Item	Min.	Тур.	Max.	Unit	Note	
VDD	Power Supply Input Range		4.5	5	5.5	[Volt]	
IDD	Current of Power	White	-	0.5	0.6	[A]	Note2-1
	Supply@60Hz	Black	-	0.4	0.5	[A]	
		H-stripe	-	0.9	1.0	[A]	
	Current of Power	White	-	0.5	0.6	[A]	
	Supply@76Hz	Black	P-10	0.4	0.5	[A]	
		H-stripe		1.0	1.3	[A]	
PDD	VDD Power	Diag	16.	2.5	3.0	[Watt]	White
	Consumption@60H	·lz	-06	LA			
	VDD Power	R	17.0	5.2	6.3	[Watt]	H-stripe
	Consumption@76h	Ηz					
IRUSH	Inrush current		-	-	3	[A]	Note2-2
VDDrp	Allowable VDD Rip	ple			500	[mV]	VDD=5.0V, White
	Voltage				cyen	YIn	Pattern
				CON		SOM	@Maxi Frame
			-111		102		rate



Note. 2-1 Test Condition:

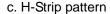
- (1) $V_{DD} = Typical$,
- (2) Temperature = 25 $^{\circ}$ C
- (3) Power dissipation check pattern (only for power design)

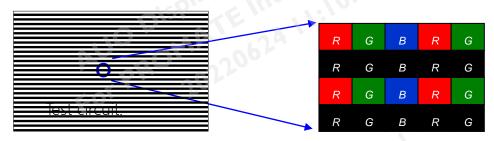


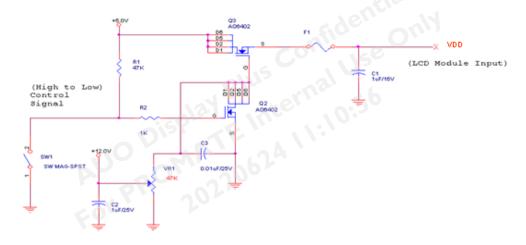


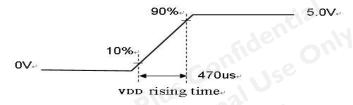
b. White pattern











The duration of VDD rising time: 470us.



4.2. Interface Connections

TFT-LCD Connector	Manufacturer	P-TWO	STM	
TFT-LCD Connector	Part Number	187034-3009	MSBKT2407P30HB	
Matina Cannastan	Manufacturer	JAE or Compatible		
Mating Connector	Part Number	FI-X30HL (Locked Type)		

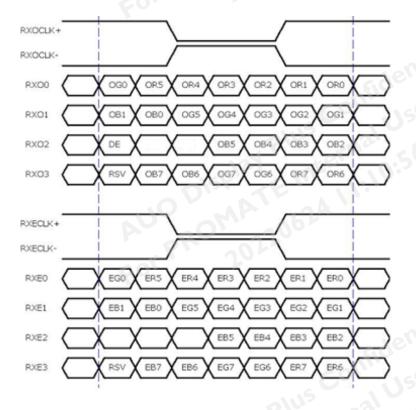
PIN#	Symbol	Description	Remark
1	RxO0-	Negative LVDS differential data input (Odd data)	
2	RxO0+	Positive LVDS differential data input (Odd data)	
3	RxO1-	Negative LVDS differential data input (Odd data)	
4	RxO1+	Positive LVDS differential data input (Odd data)	
5	RxO2-	Negative LVDS differential data input (Odd data)	
6	RxO2+	Positive LVDS differential data input (Odd data)	
7	GND	Power Ground	
0	RxOCLK-	Negative LVDS differential clock input (Odd clock)	
0	RxOCLK+	Positive LVDS differential clock input (Odd clock)	
10	RxO3-	Negative LVDS differential data input (Odd data)	
44	RxO3+	Positive LVDS differential data input (Odd data)	
10	RxE0-	Negative LVDS differential data input (Even data)	
12	RxE0+	Positive LVDS differential data input (Even data)	
1.4	GND	Power Ground	
4 F	RxE1-	Negative LVDS differential data input (Even data)	
10	RxE1+	Positive LVDS differential data input (Even data)	
17	GND	Ground	
10	RxE2-	Negative LVDS differential data input (Even data)	
10	RxE2+	Positive LVDS differential data input (Even data)	
20	RxECLK-	Negative LVDS differential clock input (Even clock)	
21	RxECLK+	Positive LVDS differential clock input (Even clock)	
22	RxE3-	Negative LVDS differential data input (Even data)	
22	RxE3+	Positive LVDS differential data input (Even data)	
2.4	NC	No connection (for AUO test only. Do not connect)	
25	NC	No connection (for AUO test only. Do not connect)	
26	NC	No connection (for AUO test only. Do not connect)	
27	NC	No connection (for AUO test only. Do not connect)	
20	VDD	Power +5V	
20	VDD	Power +5V	
20	VDD	Power +5V	



4.3. Input Data Format

<u>ıta</u>		or	<u>m</u>					91	9	10	920	1
R		В	R		В	Display Elncol	1	0				
			P			2017091					-	
								9	e			
R	G	В	R	G	В		R	G	В	R	G	В
			R G B	R G B R	R G B R G	R G B R G B	1 2 R G B R G B	1 2 1 R G B R G B	1 2 191 R G B R G B	1 2 1919 R G B R G B	1 2 1919 19 R G B R G B R G B R	1 2 1919 1920 R G B R G B

4.3.1. LVDS Colour Date Mapping



8 Bit Color Bit Order											
MSB	SB R7 G7 B7										
	R6	G6	B6								
	R5 G5 B5										
	R4	G4	B4								
	R3	G3	B3								
	R2	G2	B2								
	R1 G1 B1										
LSB	R0	G0	В0								



4.3.2. Color Input Data Reference

The following table is for color versus input data (8bit). The higher the gray level, the brighter the color.

								-0	(a)			Col	or Inp	out Da	ata	56										
Color	Gray Level				RED B:R7			-A	Á	GREEN data (MSB:G7, LSB:G0)				BLUE data (MSB:B7, LSB:B0)				Remark								
		R7	R6	R5	R4	R3	R2	R1	R0	G7	G6	G5	G4	G3	G2	G1	G0	В7	В6	B5	B4	ВЗ	В2	B1	В0	
Black	-	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
White	-	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	
Gray 127	-	0	1	1	1	1	1	1	1	0	1	1	1	1	1	1	1	0	1	1	1	1	1	1	1	
	ம	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
Red	:	:	:	:	:	:	:	:	:	:	:	:		:)		:) :	:	:	:	:	:	:	:	
	L255	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	ம	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
Green	:	:	:	:	:	:		30					:	:	Ö	:	:	:	:	:	:	:	:	:	:	
	L255	0	0	0	0	0	0	0	0	1	1	14	1	1	1	1	1	0	0	0	0	0	0	0	0	
	ம	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
Blue	:	:	:		DY.		:		V	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
	L255	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	



4.3.3. Signal Timing Specification

This is the signal timing required at the input of the user connector. All of the interface signal timing should be satisfied with the following specifications for its proper operation.

It only support DE mode, and the input timing are shown as the following table.

Signal	Item	Symbol	Min.	Тур.	Max	Unit	Remark
	Period	Tv	1094	1130	1836	Th	
	Active	Tdisp (v)	1080	1080	1080	Th	
Vertical Section	Blanking	Tblk (v)	14	50	756	Th	
	Frequency	Fv	49	60	76	Hz	
	Period	Th	1000	1050	1678	Tclk	
	Active	Tdisp (h)	960	960	960	Tclk	
Horizontal Section	Blanking	Tblk (h)	40	90	718	Tclk	
	Frequency	Fh	53.7	67.8	90.0	KHz	Note 1
LVDS Clock	Period	Tclk	11.2	14.0	18.6	ns	1/Fclk
LVD3 CIOCK	Frequency	Fclk	53.7	71.2	90.0	MHz	Note 2

Note 1: The equation is listed as following. Please don't exceed the above recommended value.

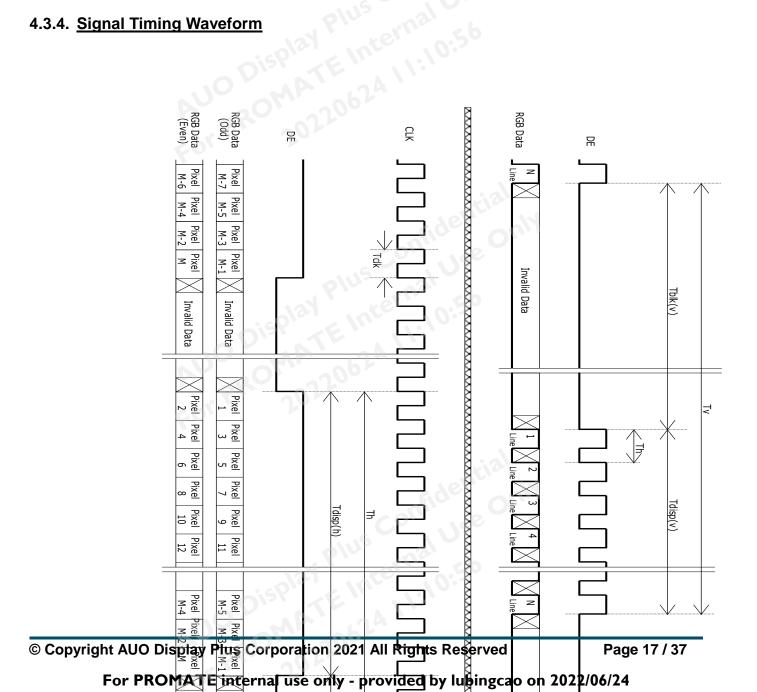
Note 2: The equation is listed as following. Please don't exceed the above recommended value.

Fclk (Min.) =
$$Fv$$
 (Min.) x Th (Min.) x Tv (Min.);



Fclk (Max.) = Fv (Max.) x Th (Typ.) x Tv (Typ.); 20220624 11:10:56

4.3.4. Signal Timing Waveform





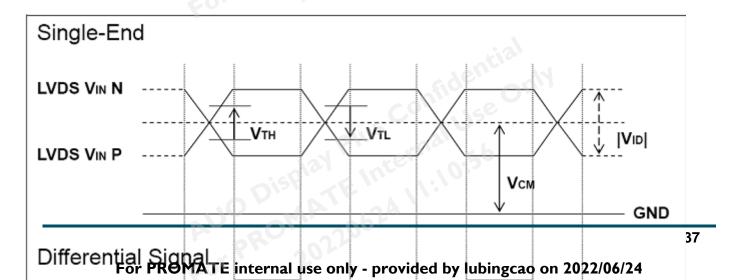
4.4. Input interface characteristics

4.4.1. DC Characteristics:

Symbol	Description	Min	Тур	Max	Units	Condition
V _{TH}	LVDS Differential Input High Threshold	<u>-</u>	ı	+100	[mV]	V _{CM} = 1.2V
V_{TL}	LVDS Differential Input Low Threshold	-100	ı	ı	[mV]	V _{CM} = 1.2V
VID	LVDS Differential Input Voltage	100	-	600	[mV]	
V _{CM}	LVDS Common Mode Voltage	+1.0	+1.2	+1.5	[V]	V_{TH} - V_{TL} = 200mV

LVDS Signal Waveform:

Use RxOCLK- & RxOCLK+ as example.

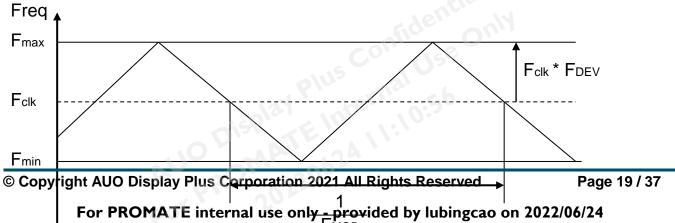




4.5. Power Sequence

4.4.2 AC Characteristics:

.4.2 AC Char	acteristics:	Inter	1:10:5	Ь	
Symbol	Description	Min	Max	Unit	Remark
	Maximum deviation of				
F _{DEV}	input clock frequency	-	± 3	%	
	during Spread Spectrum	Co	nfia	e Om	
	Maximum modulation	Inter	na.	b	
F _{MOD}	frequency of input clock	67A	200	KHz	
	during Spread Spectrum				

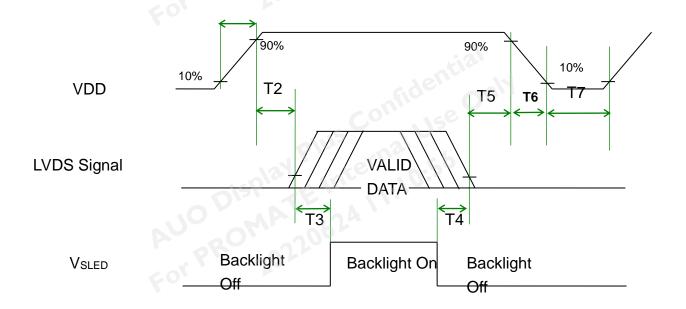






4.5. Power Sequence

Plus Confid VDD power,LVDS signal and backlight on/off sequence are as following. LVDS signals from any system shall be Hi-Z state when VDD is off.



Power Sequence Timing

Symbol		Value	Counne	Unit	Remark
	Min	Tun	May		
T1	0.5	AATE III	10	[ms]	
T2	0	202300	50	[ms]	
T3	500	-	-	[ms]	
T4	100	-	nfident	[ms]	
T5	0	Plus	50	[mc]	Note 1
15	o ois	play	30	[ms]	Note 1



T6	0	_	200	[ms]	Note 2
	C	Plus	200	[1113]	Note 3
Т7	1000	pla E In	11:70:	[ms]	

Note 1: Recommend setting T5 = 0ms to avoid electronic noise when VDD is off.

Note 2: During T5 and T6 period, please keep the level of input LVDS signals with Hi-Z state.

Note 3: Voltage of VDD must decay smoothly after power-off.(customer system decide this value)



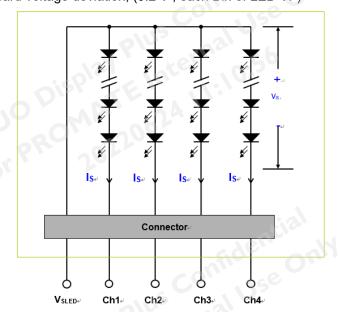
5. Backlight Specification

The following shows the block diagram of the 21.5 inch Backlight Unit. And it includes 60 pcs LED in the LED light bar. (4 strings and 15 pcs LED of one string).

Parameter	oisy'.	Cymhal		Values	;	Unit	Note
r ai ailletei		Symbol	Min	Тур	Max	Unit	Note
Forward Current	Anode	IF (anode)		260		mA	
(one light bar)	Cathode	IF (cathode)		65		mA	
Peak Forward Current		IFP			800	mA	<1msec.
Forward Voltage		VF		42.8	49.8	V	1
Maximum ΔVs Voltage		ΔVs	. 16		3	V	6
Deviation of light bar		∆ V S	160	0	3	V	O
Total Power Consumption (4 I	ight bars)	PBL		11.4	12.95	W	2,3
LED MTTF		LTLED	30000	4		Hr	4, 5

- Note 1: The recommended power forward voltage capacity of converter/lips design should reserve 10% upper margin for successful light bar driving under different ambient temperature variation range (5~40°C) application and the corresponding environmental stress continued by time.
- Note 2: Each LED string should be driven by independent current control/feedback circuit.
- Note 3: Fuse protection should be added into LIPS circuit to have better LED driving protection.
- Note4: The lifetime is defined as the time which luminance of LED is 50% compared to its original value. [Operating condition: Continuous operating at Ta = 25±2°C]
- Note 5: MTTF is a reference index, it is not representative of warranty.
- Note 6: ΔVs (Max.) = ΔVF X LED No. (one string);

ΔVF: LED chip forward voltage deviation; (0.2 V , each Bin of LED VF)





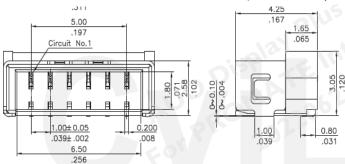
5.1. Interface Connection

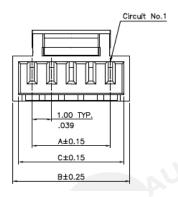
5.1.1. Connector Type:

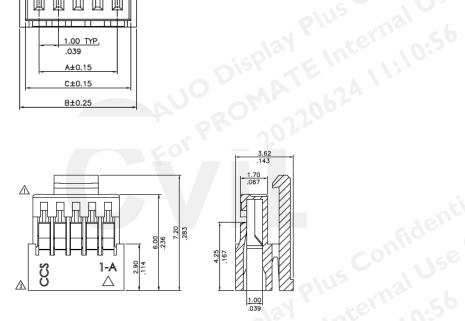
AUO Display+		wi2l	IXEV.
.1. Interface Connection	<u>on</u>	siden only	
1.1. Connector Type:		ne Courinse	
Backlight Connector	Manufacturer	CviLux	
Buokinghi Commodol	Part Number	CI1406M1HRN-NH1	
Mating Connector	Manufacturer	CviLux	
Mating Connector	Part Number	CI1406SL000-NH (Lock type)	

Backlight Connector dimension:

$$H \times V \times D = \text{HxVxD} = 7.9 \text{x} \cdot 3.05 \text{x} \cdot 425, \text{Pitch} = 1.0 (unit = mm)$$





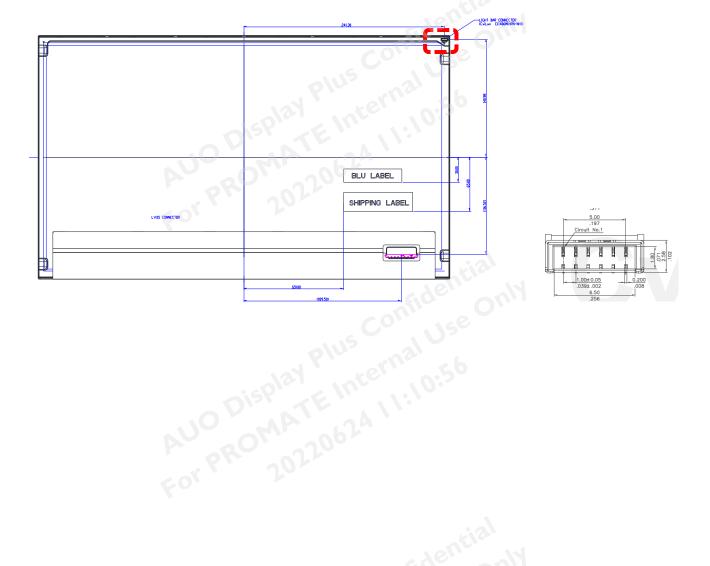






5.1.2. Connector Pin Assignment

1.2. <u>Cor</u>	nnector Pin A	ssignment	
Pin#	Symbol	Description	Remark
1	Ch1	LED Current Feedback Terminal (Channel 1)	
2	Ch2	LED Current Feedback Terminal (Channel 2)	
3	Vsled	LED Power Supply Voltage Input Terminal	
4	Vsled	LED Power Supply Voltage Input Terminal	
5	Ch3	LED Current Feedback Terminal (Channel 3)	
6	Ch4	LED Current Feedback Terminal (Channel 4)	





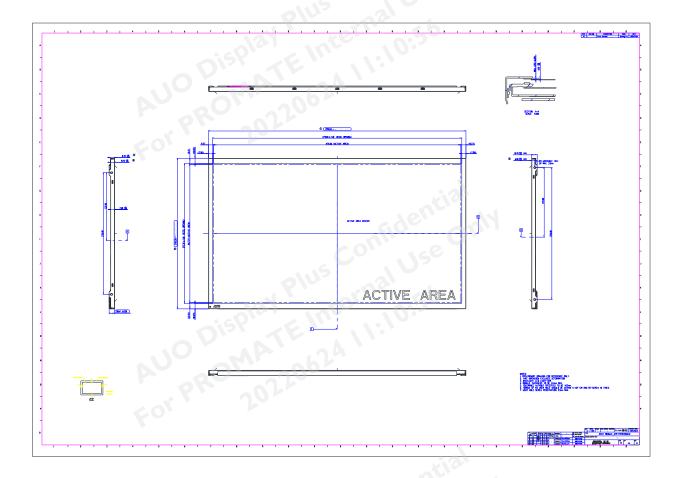
6. Mechanical Characteristics

The contents provide general mechanical characteristics for the model P215HAN01.2. In addition, the figures in the next page are detailed mechanical drawing of the LCD.

ı	tem	Dimension	Unit	Note
	Horizontal	495.6	mm	
	Vertical	292.2	mm	
	Depth (Dmin)	7.6	Se Omm	Front bezel to Back Bezel
Outline Dimension	Depth (Dmax)	10.7	mm	
	Bezel opening	479.8(H) x 271.3(V)	mm	
	Bezel Width	10.45/10.45/7.9/7.9	mm	U/D/L/R
	Display Area	476.06 (H) x 267.79(V)	mm	
Weight	1.	8	Kg	

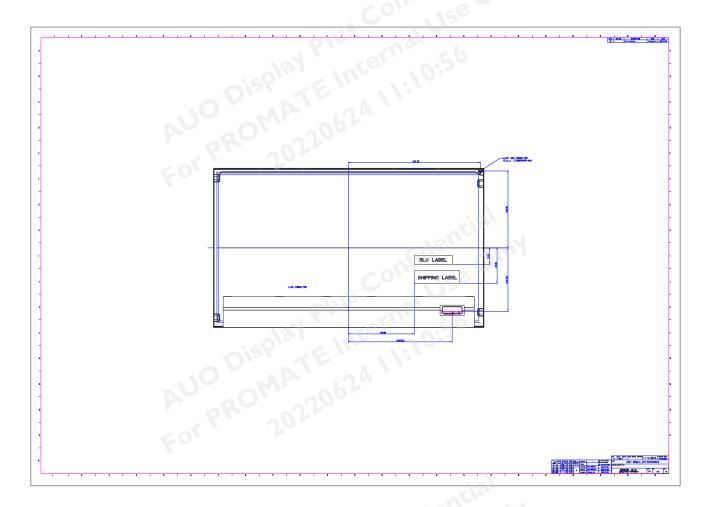


Front view





Back View





7. Reliability Test Items

	Test Item	Q'ty	Condition	
	High temperature storage test	3	60°C, 500hrs	
	Low temperature storage test	3	-20°C, 500hrs	
	High temperature operation test	3	50°C, 500hrs	
	High temperature and High humidity operation (THB)	3	50°C 80%, 500hrs	
5	Low temperature operation test	3	0℃, 500hrs	
6	Vibration test (With carton)	1(PKG)	Random wave (1.04Grms 2~200Hz) Duration: X,Y, Z 30min per axes	
	Drop test (With carton)		Height: 45.7 cm Direction: 1corner 3edges 6flats (ASTM D 4169 & D 5276)	



8. International Standard

8.1. Safety

- (1) UL 62368-1: Audio/video, information and communication technology equipment Part 1: Safety requirements
- (2) IEC 62368-1: Audio/video, information and communication technology equipment -Part 1: Safety requirements
- (3) EN 62368-1: Audio/video, information and communication technology equipment -Part 1: Safety requirements

8.2. EMC

- (1) ANSI C63.4 "Methods of Measurement of Radio-Noise Emissions from Low-Voltage Electrical and Electrical Equipment in the Range of 9kHz to 40GHz. "American National standards Institute(ANSI), 1992
- (2) C.I.S.P.R "Limits and Methods of Measurement of Radio Interface Characteristics of Information Technology Equipment." International Special committee on Radio Interference.
- (3) EN 55022 "Limits and Methods of Measurement of Radio Interface Characteristics of Information Technology Equipment." European Committee for Electro technical Standardization. (CENELEC), 1998

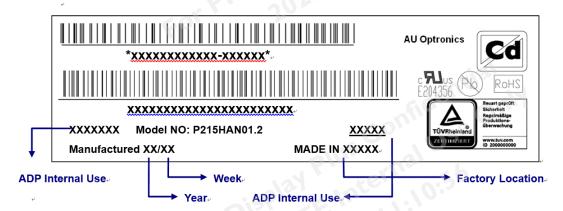


9. Packing

9.1. **DEFINITION OF LABEL:**

A. Panel Label:





Green mark description

P215HAN01.2

(1) For Pb Free Product, AUO will add

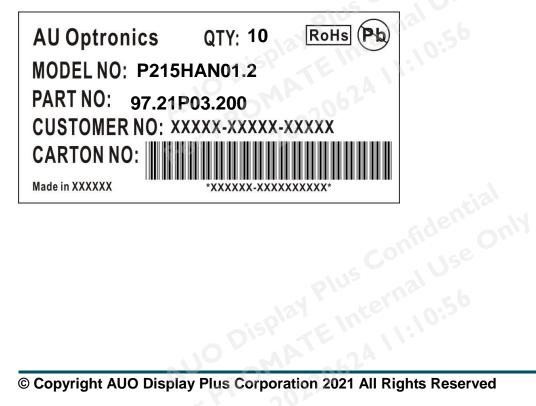


for identification.

(2) For RoHs compatible products, AUO will add RoHS for identification.

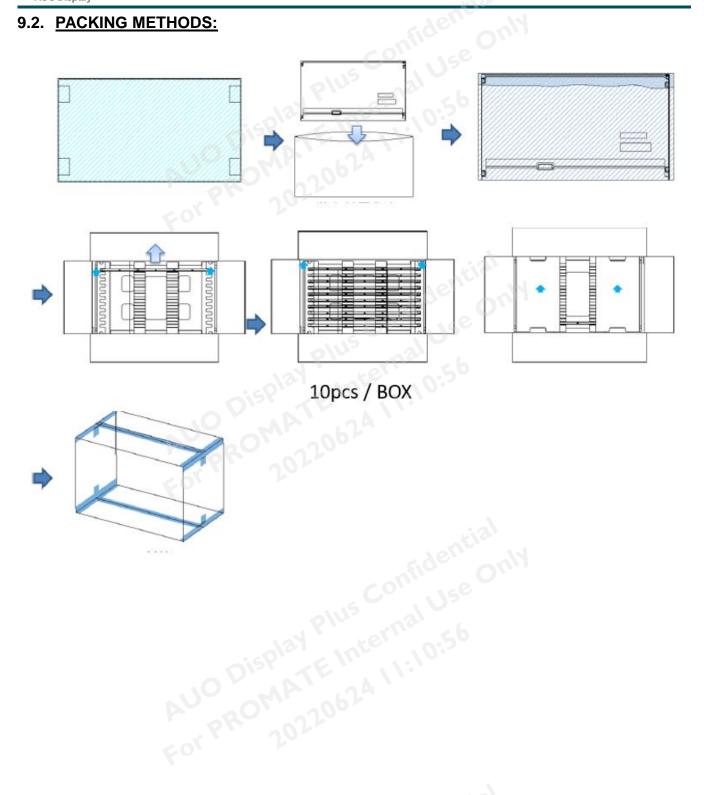
Note: The green Mark will be present only when the green documents have been ready by AUO internal green team. (definition of green design follows the AUO green design checklist.) Use Only

B. Carton Label:





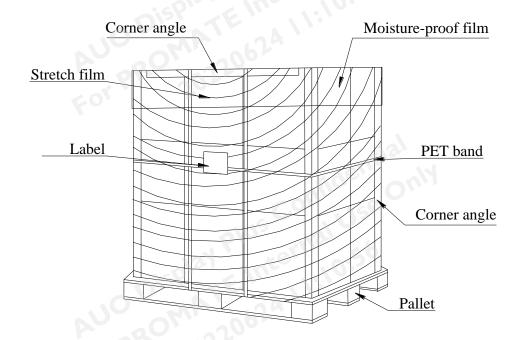
9.2. PACKING METHODS:





Pallet and Shipment Information

		Qty.	Dimension	Weight	Packing Remark
	Item		rether 56	(kg)	
1	Packing Box	10pcs/box	565mm*345mm*375mm	19.4	With panel &Box
		10 V			& Cushion
2	Pallet	1	1150mm*1070mm*132mm	15.9	
3	Boxes per Pallet	18 Box per Pall			
4	Panels per Pallet	180pcs/pallet			
5	Pallet after packing	180pcs/pallet	1150(L)mm x 1070(W)mm x 1257(H)mm	349.2	With Pallet
		(by Air)	ntia		
	Pallet after packing	180pcs/pallet	1150(L)mm x 1070(W)mm x 1257(H)mm	1	With Pallet
		(by Sea)	Col., 126		





10. PRECAUTIONS

Please pay attention to the followings when you use this TFT LCD module.

10.1. MOUNTING PRECAUTIONS

- (1) You must mount a module using holes arranged in four corners or four sides.
- (2) You should consider the mounting structure so that uneven force (ex. twisted stress) is not applied to module. And the case on which a module is mounted should have sufficient strength so that external force is not transmitted directly to the module.
- (3) Please attach the surface transparent protective plate to the surface in order to protect the polarizer. Transparent protective plate should have sufficient strength in order to the resist external force.
- (4) You should adopt radiation structure to satisfy the temperature specification.
- (5) Acetic acid type and chlorine type materials for the cover case are not desirable because the former generates corrosive gas of attacking the polarizer at high temperature and the latter cause circuit broken by electro-chemical reaction.
- (6) Do not touch, push or rub the exposed polarizer with glass, tweezers or anything harder than HB pencil lead. And please do not rub with dust clothes with chemical treatment. Do not touch the surface of polarizer for bare hand or greasy cloth. (Some cosmetics are detrimental to the polarizer.)
- (7) When the surface becomes dusty, please wipe gently with absorbent cotton or other soft materials like chamois soaks with petroleum benzene. Normal-hexane is recommended for cleaning the adhesives used to attach front/ rear polarizer. Do not use acetone, toluene and alcohol because they cause chemical damage to the polarizer.
- (8) Wipe off saliva or water drops as soon as possible. Their long time contact with polarizer causes deformations and color fading.
- (9) Do not open the case because inside circuits do not have sufficient strength.

10.2. OPERATING PRECAUTIONS

- (1) The device listed in the product specification sheets was designed and manufactured for PID application
- (2) The spike noise causes the miss-operation of circuits. It should be lower than following voltage: V=±200mV(Over and under shoot voltage)
- (3) Response time depends on the temperature. (In lower temperature, it becomes longer..)
- (4) Brightness of LED depends on the temperature. (In lower temperature, it becomes lower.) And in lower temperature, response time (required time that brightness is stable after turned on) becomes longer.
- (5) Be careful for condensation at sudden temperature change. Condensation makes damage to polarizer or electrical contacted parts. And after fading condensation, smear or spot will occur.
- (6) When fixed patterns are displayed for a long time, remnant image is likely to occur.
- (7) Module has high frequency circuits. Sufficient suppression to the electromagnetic interference shall



be done by system manufacturers. Grounding and shielding methods may be important to minimize the interface.

10.3. Operating Condition for Public Information Display

The device listed in the product specification is designed and manufactured for PID (Public Information Display) application. To optimize module's lifetime and function, below operating usages are required.

- (1) Normal operating condition
 - 1. Operating temperature: 0~40°C
 - 2. Operating humidity: 10~90%
 - Display pattern: dynamic pattern (Real display).
 Note) Long-term static display would cause image sticking.
- (2) Operation usage to protect against image sticking due to long-term static display.
 - (1) Suitable operating time: 20 hours a day or less.
 - (* The moving picture can be allowed for 24 hours a day)
 - (2) Liquid Crystal refresh time is required. Cycling display between 5 minutes' information (static) display and 10 seconds' moving image.
 - (3) Periodically change background and character (image) color.
 - (4) Avoid combination of background and character with large different luminance.
- (3) Periodically adopt one of the following actions after long time display.
 - A. Running the screen saver (motion picture or black pattern)
 - B. Power off the system for a while
- (4) LCD system is required to place in well-ventilated environment. Adapting active cooling system is highly recommended.
- (5)Product reliability and functions are only guaranteed when the product is used under right operation usages. If product will be used in extreme conditions, such as high temperature/ humidity, display stationary patterns, or long operation time etc..., it is strongly recommended to contact AUO for filed application engineering advice. Otherwise, its reliability and function may not be guaranteed. Extreme conditions are commonly found at airports, transit stations, banks, stock market and controlling systems.

10.4. Electrostatic Discharge Control

Since a module is composed of electronic circuits, it is not strong to electrostatic discharge. Make certain that treatment persons are connected to ground through wristband etc. And don't touch interface pin directly.

10.5. Precautions for Strong Light Exposure

Strong light exposure causes degradation of polarizer and color filter.

10.6. Storage

When storing modules as spares for a long time, the following precautions are necessary.

(1) Store them in a dark place. Do not expose the module to sunlight or fluorescent light. Keep the temperature between 5°Cand 35°Cat normal humidity.



- (2) The polarizer surface should not come in contact with any other object. It is recommended that they be stored in the container in which they were shipped.
- (3) Storage condition is guaranteed under packing conditions.
- (4) The phase transition of Liquid Crystal in the condition of the low or high storage temperature will be recovered when the LCD module returns to the normal condition.

10.7. Handling Precautions for Protection Film

- (1) The protection film is attached to the bezel with a small masking tape. When the protection film is peeled off, static electricity is generated between the film and polarizer. This should be peeled off slowly and carefully by people who are electrically grounded and with well ion-blown equipment or in such a condition, etc.
- (2) When the module with protection film attached is stored for a long time, sometimes there remains a very small amount of glue still on the bezel after the protection film is peeled off.
- (3) You can remove the glue easily. When the glue remains on the bezel or its vestige is recognized, please wipe them off with absorbent cotton waste or other soft material like chamois soaked with normal-hexane.

10.8. Dust Resistance

- (1) ADP module dust tests are conducted with marked areas (e.g., holes and slits around the front bezel and back cover) sealed, to comply with JIS D0207 (see Figure 1).
- (2) To prevent particles from entering the module, please ensure the set has all the highlighted areas (holes and slits) adequately sealed or covered by set mechanism.
- (3) ADP's testing procedure cannot replicate all real world operation scenarios. It is up to the module user to apply the most appropriate dust resistance solution for its particular application.

Figure 1

